Silicon-Based Single Quantum Dot Emission in the Telecoms C-Band

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Supporting Information

ABSTRACT: We report the observation of single quantum dot (QD) emission in the telecoms C-band (1530–1565 nm) from an InAs QD structure grown on a Si substrate. A large red-shift of the emission is achieved by capping InAs QDs with a thin GaAsSb layer. Sharp lines, representing emission from single QDs, are observed out to wavelengths as long as 1540 nm. Comparison is made to the optical properties of a nominally identical active region structure grown on a GaAs substrate. Single QD emission from a Si-based system at 1500 nm has the potential for single photon sources compatible with current optical fibers and reduced complexity of integration with drive electronics.

KEYWORDS: single-photon sources, quantum dots, Si substrate, C-band, III–V semiconductors, GaAsSb

The unique, discrete electronic density of states exhibited by semiconductor quantum dots (QDs) provides many applications for both conventional and novel light emitters. An example of the latter is the single photon source, with application in the field of quantum cryptography. Here a single QD is loaded optically or electrically with a quasi-random number of excitons. Because the photon energy resulting from a recombining exciton is dependent on the number of excitons remaining in the dot, subsequent radiative decay of the excitons gives rise to a sequence of photons, each exhibiting a different energy. The photon produced by the recombination of the final exciton can be spectrally selected, hence, giving exactly one photon for each excitation event, independent of the number of excitons initially excited.¹ Semiconductor QDs therefore provide highly compact and efficient on-demand sources of single photons.

While GaAs-based QD single photon sources at 900–1300 nm²⁻⁴ and InP-based sources in the telecoms C-band at 1550 nm⁵ have been demonstrated, a Si-based C-band source, allowing direct integration with Si-based drive electronics, is highly desirable. Extension of the emission wavelength from QDs grown within a GaAs matrix has been demonstrated by capping InAs QDs with a thin GaAsSb layer; room temperature emission out to ~1600 nm has been achieved.⁶⁻²³ Detailed structural studies reveal that capping InAs QDs with GaAsSb prevents the decomposition observed when capping with GaAs. GaAsSb capped QDs were found to have a height approximately twice that of GaAs capped dots; the lateral sizes appeared to be very similar. The initial height of the QDs was found to be retained for a Sb composition greater than 14%.²² This suppression of the decomposition was attributed to the reduced lattice mismatch between InAs and GaAsSb, compared to InAs and GaAs.¹¹ In addition, it is well documented that capping QDs with a strain reducing layer (for example, InGaAs, but also GaAsSb) results in a red shift of the emission.²³ A third mechanism contributing to the extension of the emission wavelength is a transition to a type-II system for Sb compositions above ~14%,²⁴⁻²⁶ with the hole localized in the GaAsSb two-dimensional layer and the electron in the QD. Related to the structures studied in the present work are GaSb QDs and quantum rings grown in a GaAs matrix.²⁵⁻²⁹ These also form a type-II system but with the electrons localized in the GaAs and holes in the QD or ring.²⁵⁻²⁹ Emission wavelengths around ~1.3 μm are typically observed.²⁴⁻²⁵,²⁷

In this paper we report the observation of single QD emission at wavelengths as long as 1540 nm from InAs QDs capped with a 6 nm GaAs₀.₇₄Sb₀.₂₆ layer and grown directly on a Si substrate. As the number of QDs probed decreases, the inhomogeneously broadened emission breaks up into a small number of sharp lines, each line corresponding to emission from excitons localized in different QDs. Comparison is made...
to a nominally identical reference sample grown on a GaAs substrate. The present results suggest the potential for Si-based single photon sources emitting in the C-band.

Two samples were grown by solid-source III–V molecular beam epitaxy (MBE) on Si and [001] GaAs substrates. Both active regions were identical and consisted of 50 nm of GaAs followed by a single low density InAs QD layer capped with 6 nm of GaAs0.74Sb0.26 and 50 nm of GaAs. These layers were grown at ~510 °C. Both sides were clad with a 100 nm Al0.3Ga0.7As layer grown at 610 °C and the structure was terminated with a 50 nm GaAs layer grown at 580 °C. The Si structure was grown directly on an n-doped Si (100) substrate with 4° offset to the [011] plane. This substrate orientation is used to suppress the formation of antiphase domains in the III–V material.32 Oxide desorption of the substrate was performed at 900 °C for 15 min, followed by a cool down to 370 °C and the growth of a 200 nm GaAs nucleation layer comprising an optimized two-step growth scheme.33–35 An 800 nm GaAs buffer layer was deposited, followed by three dislocation filter layers (DFLs). These were included to reduce the number of dislocations, which form at the Si:III–V interface, propagating into the device active region where they degrade the optical efficiency. DFLs are highly effective in improving the performance of QD lasers grown on Si substrates, reducing the dislocation density from ~10^6 cm^{-2} at the Si:III–V interface to ~10^5 cm^{-2} in the active region.36

The Abstract graphic shows a schematic of the Si-substrate structure, including the two methods used to isolate a small number of QDs: etched micropillars and holes in a metal mask. The vertical scale is exaggerated to clearly show the different epitaxial layers; in the actual structures the aspect ratio of the pillars is close to unity (see Figure 3 below).

Figure 1a shows a dark field 002 transmission electron microscopy (TEM) image of a single GaAsSb capped InAs QD. A number of QDs were examined and found to be of similar size and shape; the image shown is a representative example. Tilting of the TEM specimen showed that it was ~50 nm thick, completely containing the QD; the specimen shape and size revealed in this image should therefore be accurate. The contrast is roughly proportional to the square of the difference in mean atomic number of the group III and V atoms (Z_{III} − Z_{V})^2, with an amplitude integrated through the specimen thickness; thus, the GaAsSb layer appears bright, while the GaAs matrix is dark. The InAs QD also appears dark due to a change in sign of (Z_{III} − Z_{V}) compared to the GaAsSb cap. The InAs QD has a height ~8 nm and width ~23 nm. These values are reasonably consistent with previous cross-sectional scanning tunneling microscopy (X-STM) studies of a very similar structure, which found a height of 9.5 nm and a width of 32 nm, although the QDs had a more pyramidal shape.37 The GaAsSb capping layer appears to be nonuniform close to the QD, with a “ring-like” variation in thickness. A similar structure was observed in X-STM38 for samples where the GaAsSb was grown at 500 °C. This was attributed to migration of material away from the apex of the dot, hence minimizing the strain.

Figure 1b shows an annular dark field (ADF) scanning TEM image of a second GaAsSb capped InAs QD along with energy-dispersive X-ray spectroscopy (EDX) composition maps of the elements Ga, As, In and Sb. Contrast in the ADF-STEM image increases with atomic number, and the QD appears only slightly brighter than the surrounding material. The QD/cap interface in the In map is diffuse, making it difficult to accurately determine the QD height; the In composition profile indicates a value between 6.5 and 9.5 nm. Away from the QD, the GaAsSb layer has a thickness of ~5−6 nm, consistent with a value of 6 nm estimated from the growth conditions. The In map reveals a nonzero In composition in the nominal GaAsSb capping layer, a result of In diffusion or segregation during growth. The incorporation of In will reduce the band gap of this layer.

Figure 1c shows an atomic force microscopy (AFM) image of an uncapped layer of QDs grown under the same conditions as the capped QDs used for optical studies. Visible in the image are two subsets of QDs. The distribution of the large QDs exhibits a significant spatial variation with a low average density, estimated to be of order 5 μm^{-2}. These dots also exhibit a broad size distribution. The subset of smaller QDs has a much larger density ~80 μm^{-2}. We show below that the larger QDs are responsible for emission in the 1500 nm spectral region.

The structural images shown in Figure 1a,b were obtained for a sample grown on a GaAs substrate, the AFM image is for growth on Si. Previous structural studies of QDs grown on both Si and GaAs substrates have shown no significant differences in
shape, size, and density. This is expected as a large thickness (>1 μm) of GaAs is deposited on the Si substrate before the QDs are grown. In addition, optical studies have revealed the QDs to have very similar properties apart from a small energy shift of the emission for QDs grown on a Si substrate. This shift is attributed to residual strain (0.24% at a temperature of 77 K) that results from the different III–V and Si thermal expansion coefficients and cool down following growth. In the optical data present below, both sets of QDs emit at essentially the same wavelengths for the Si and GaAs substrate samples, confirming very similar physical structures.

Initial optical characterization was performed for a sample temperature of 77 K with photoluminescence (PL) excited by a 638 nm laser focused to a diameter ~200 μm; probing approximately 6000 of the larger dots. Figure 2a shows spectra recorded for excitation powers between 5 and 30 mW (~1270 nm in (b), produced by second order scattered laser light, has been removed to aid clarity. The inset to (a) shows the ratio of the PL intensity for the Si to GaAs grown samples for a laser power of 30 mW. Although the ratio is always less than unity, peaks are observed at ∼1100 and ∼1500 nm, corresponding to emission from the two subsets of QDs, demonstrating their reduced sensitivity to nonradiative defects. The optical efficiency of the Si substrate sample could be increased by including annealing steps during growth to further improve the effectiveness of the DFLs; this has been shown to significantly increase the optical efficiency of test structures and the performance of QD lasers.

In order to observe single QD emission, the samples were etched into arrays of 1 μm diameter pillars with a pitch of 5 μm (Figure 3). The arrays were patterned using e-beam lithography and etched to a depth ~450 nm using inductive coupled plasma etching (ICP). The samples were cooled to ~20 K in a closed loop helium cryostat. A 50× IR high NA microscope objective lens was used for both excitation and PL collection, giving a laser spot diameter of ~3 μm for excitation with a 532 nm laser. PL was detected by a thermoelectric cooled InGaAs array. Data from GaAs array was taken at ~90 °C to reduce thermal noise/dark currents, giving a quantum efficiency of ~76% at 1550 nm.

Figure 4 shows typical low power spectra from four pillars: (a) GaAs substrate, laser power 0.2 μW, and (b) Si substrate, laser power 2 μW. All spectra show a number of sharp lines on a broad background. Each sharp line is attributed to emission of GaAsSb capping layers as captured carriers are able to migrate in-plane until they reach a dislocation. No emission is observed from either layer in the Si substrate sample. In contrast, although the QD emission is reduced in intensity, it is still visible because carrier capture by a QD inhibits subsequent migration to a dislocation. In contrast to the GaAs substrate sample, emission from the lower density, larger QDs is more intense than that of the higher density, smaller QDs. This most likely reflects the much deeper confining potential of the larger QDs, which provides a strong barrier preventing carrier migration to dislocations. The differing behavior of the QD and bulk/2D layers is demonstrated in the inset to Figure 2a, which plots the PL intensity ratio of the Si/GaAs samples for a laser power of 30 mW. Although the ratio is always less than unity, peaks are observed at ~1100 and ~1500 nm, corresponding to emission from the two subsets of QDs, demonstrating their reduced sensitivity to nonradiative defects. The optical efficiency of the Si substrate sample could be increased by including annealing steps during growth to further improve the effectiveness of the DFLs; this has been shown to significantly increase the optical efficiency of test structures and the performance of QD lasers.

Figure 2. Macro PL (77 K) spectra: (a) Sample grown on a GaAs substrate; (b) Sample grown on a Si substrate. A sharp feature at ∼1270 nm in (b), produced by second order scattered laser light, has been removed to aid clarity. The inset to (a) shows the ratio of the PL intensity for the Si to GaAs grown samples for a laser power of 30 mW.
from one of the small number of QDs isolated by the ~1 μm diameter pillars. For the Si substrate sample, the longest observed single dot emission is 1540 nm, for the GaAs substrate sample it is 1510 nm. To the best of our knowledge this is the first reported observation of single QD emission at 1500 nm from QDs grown on Si or GaAs substrates. Si-based single QD emission at this wavelength is particularly significant as it provides the potential for single photon sources emitting at the minimum absorption of silica optical fibers and with simpler integration with drive electronics.

A greater variation in the PL intensity between different pillars fabricated from the Si substrate sample is observed than is the case for the GaAs sample. This stronger variation may reflect the presence of a random number of dislocations in different pillars. However, the incorporation of the three DFLs should reduce the defect density in the active region to ~10⁶ cm−² corresponding to an average of only one defect for every hundred pillars.

For both the GaAs and Si substrate samples the single QD emission sits on a broad background (Figure 4). For the laser powers used to record these spectra (0.2 and 2 μW for the GaAs and Si samples, respectively), the QD peak to background intensity ratio is approximately unity; for higher powers (above 2 μW for the GaAs sample), the ratio decreases, reaching a value ~0.1 for a power of 20 μW (GaAs sample).

The origin of this background emission is unclear but is most likely the result of additional exciton confining centers in close proximity to the QD. For a single photon source the presence of a background would degrade the fidelity via the production of additional photons at the same wavelength as the QD emission. The current samples were designed to study the properties of the QDs and were not optimized for single photon sources. Further studies are necessary to reduce the background emission, for example, by optimizing confinement of carriers close to the QD and lowering the QD density. In addition, the collected signal from the QD’s emission can be dramatically increased by the addition of an optical cavity.40

Figure 5 shows spectra for an excitation range of 0.4 to 300 μW (≡ 6−4500 W cm⁻²) for a pillar fabricated from the GaAs substrate sample. This sample was chosen for detailed study as the higher PL efficiency allowed for a greater range of laser powers. At high excitation powers a continuous spectrum is observed, with a maximum at 1430 nm and emission extending beyond 1560 nm. As the power is decreased, the emission peak shifts to longer wavelength before breaking up into a number of discrete peaks, the positions of which shift very weakly with excitation power. This behavior is similar to that reported for type-II GaSb/GaAs quantum rings.41 Here the blue shift of the emission was attributed to emission from higher energy QD states rather than the band bending predicted for a type-II system.9 The right-hand panel of Figure 5 shows the wavelength and total intensity (obtained by multiplying the intensity by the peak intensity) of the sharp feature observed close to 1450 nm, plotted against laser power. At low powers the intensity exhibits a nearly linear dependence on laser power. At high powers the intensity exhibits a nearly linear dependence on laser power (gradient of 0.95 ± 0.06 on a log-log plot) before saturating at high powers. This is consistent with single-exciton recombination. No evidence for additional lines at high power, likely the result of additional exciton confinement, is observed; these may be obscured by the broad background. The 1450 nm feature exhibits a weak redshift at high powers which may result from sample heating. There is also an increase in line width from 3.6 nm at 0.4 μW to 6 nm at 10 μW (≡ 2.3−3.8 meV). A similar power dependent behavior to that shown in Figure 5 is observed for the sample grown on a Si substrate. The PL...
intensity exhibits an initial approximate linear intensity increase, with the rate decreasing at higher powers. For this sample the saturation at high powers is less pronounced because powers higher than obtainable with the current experimental setup are required, given the lower optical efficiency. The maximum single QD emission intensity is comparable for the two samples.

The line widths of the single QD emission from both the Si and GaAs substrate samples show a range of values between ~1.3 and 5 meV. These values are significantly larger than observed in type-I QD systems where line widths of ~10 µeV can be typically achieved for high quality InAs dots grown in a GaAs matrix and for nonresonant optical excitation. The current experimental system has measured line widths as small as 200 µeV for type-II GaSb/GaAs quantum rings emitting at 1200 nm, indicating that the current line widths are not resolution limited. It is known that fluctuating carrier occupancy of states in the vicinity of a QD can increase the emission line width via local electric fields and the resultant quantum confined Stark effect (QCSE). The QCSE for an infinite depth quantum well is proportional to the fourth power of the well width. Hence, in a type-II system, with spatially separated electrons and holes, the response to fluctuating electric fields is likely to be much larger than in a type-I system where the spatial separation of the electron and hole is significantly smaller. Calculations for InAs QDs capped with a 6 nm GaAsSb layer give large zero-field dipole moments of 2.3 and 9 nm along the growth axis and in-plane, respectively. In contrast, a much smaller growth axis value of 0.4 nm has been measured for type-I InAs QDs within a GaAs matrix. Similarly type-I QDs with axial symmetry should possess a zero or, at most, small in-plane dipole moment.

Line width broadening by charge fluctuations can be particularly significant in etched mesa structures where there may be a large number of surface states close to the QDs. To study possible effects of side wall surface states, a small number of quantum dots were isolated by forming 1 µm apertures in an opaque metal mask. Such structures avoid the presence of etched semiconductor surfaces. Again both samples exhibit a series of sharp lines, with line widths in the range ~3–5 meV. These slightly larger line widths may result from the need to use significant higher laser powers (5 µW and 20 µW for the GaAs and Si substrate structures, respectively) due to the reduced in/out coupling efficiency of the apertures; measurements discussed above show a power dependent emission line width. There is, hence, no evidence for significantly lower emission line widths in the aperture structures, demonstrating that surface state induced fluctuating electric fields are not the dominant cause of the observed ~1 meV values. However, it is not possible to rule out the effects of charge fluctuations in bulk states which may have a relatively large effect due to the high laser powers and the type-II nature of the optical transitions.

A possible additional contribution to the QD line width results from the localization of the hole in the GaAsSb layer. Thickness fluctuations result in a broadening of the emission, with further broadening due to alloy fluctuations. It is difficult to estimate the size of this broadening; the TEM image of Figure 1a shows a highly nonuniform GaAsSb layer thickness and X-STM images of similar samples reveal a nonuniform Sb composition. A structural study of InAs QDs capped with a GaAs0.75Sb0.25 layer shows significant alloy fluctuations (~12%) with Sb-rich clusters of lateral dimensions between 10 and 20 nm. For relatively large composition and/or layer thickness fluctuations, the GaAsSb layer will break up into a series of quasi-QDs with full spatial localization of the hole. However, in this case, spectral broadening is still possible via the population of different hole states during the many recombination processes that occur within the integration time required to acquire the PL spectra.

In conclusion, we have reported the observation of single QD emission at telecoms wavelengths from QDs grown on a Si substrate. Emission at 1500 nm is achieved by capping InAs QDs with a thin GaAsSb layer which results in larger dots and a type-II system. Line widths are significantly larger than observed for type-I InAs QDs grown in a GaAs matrix. The broadening observed in the current samples is attributed to the high carrier densities required to excite the PL, with a possible contribution from alloy and layer thickness fluctuations in the hole confining GaAsSb layer. The observation of single QD emission at 1500 nm gives the potential for single photon sources at telecommunication wavelengths. With further growth developments the current structure could be made compatible with CMOS technology, giving the potential for direct integration with Si drive electronics.

**REFERENCES**


